

FXT Series 1,000 Watt

DC/DC Converters



Product Overview

The 4:1 Input Voltage 1,000-Watt Single FXT DC/DC converter provides a precisely regulated DC output. The output voltage is fully isolated from the input, allowing the output to be positive or negative polarity and with various ground connections. The 1,000 Watt FXT meets the most rigorous performance standards in an industry standard footprint for mobile (12Vin), and process control (24Vin).

The 4:1 Input Voltage 1,000W FXT includes trim and remote ON/OFF. Threaded through holes are provided for easy mounting or addition of a heatsink for extended temperature operation.

The converter's high efficiency and high-power density use a high-efficiency synchronous rectification technology, advanced electronic circuit, packaging, and thermal design thus resulting in a high reliability product. Converter operates at a fixed frequency and follows conservative component derating guidelines.

The FXT Series is designed and manufactured in the USA.

Model	Input Range VDC		Vout VDC	Iout ADC
	Min.	Max.		
24S12.84FXT (ROHS)	9	36	12	84
24S24.42FXT (ROHS)	9	36	24	42
24S28.36FXT (ROHS)	9	36	28	36
24S48.21FXT (ROHS)	9	36	48	21
24S53.19FXT (ROHS)	9	36	53	19

Features

- 4:1 Input Voltage Range
- High power density
- Small size 2.5" x 4.7" x 0.52"
- Efficiency up to 96%
- Excellent thermal performance with metal case
- Encapsulated
- Over-Current and Short Circuit Protection
- Over-Temperature protection
- Auto-restart
- Monotonic startup into pre bias
- Constant frequency
- Remote ON/OFF
- Good shock and vibration damping
- Temperature Range -40°C to +105°C available.
- RoHS Compliant
 - Negative Logic ON/OFF feature available. Add "-N" to the part number when ordering. For example, 24S24.42FXT-N (ROHS).
 - Designed to meet MIL-STD-810G for functional shock and vibration. The unit must be properly secured to the interface medium (PCB/Chassis) by use of the threaded inserts of the unit.
 - A thermal management device, such as a heatsink, is required to ensure proper operation of this device. The thermal management medium is required to maintain baseplate < 105°C for full rated power.
 - Non-Standard output voltages are available. Contact the factory for additional information.

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Electrical Specifications

Conditions: TA = 25 °C, Airflow = 300 LFM (1.5 m/s), Vin = 24VDC, unless otherwise specified. Specifications are subject to change without notice.

All Models					
Parameter	Notes	Min.	Typical/ Nominal	Max.	Units
Absolute Maximum Ratings					
Input Voltage	Continuous	0		40	V
	Transient (100ms)			50	V
Operating Temperature	Baseplate (100% load)	-40		105	°C
Storage Temperature		-55		125	°C
Isolation Characteristics and Safety					
Isolation Voltage	Input to Output	2250			V
	Input to Baseplate & Output to Baseplate	1500			V
Isolation Capacitance			9000		pF
Isolation Resistance		10	20		MΩ
Insulation Safety Rating			Basic		
Designed to meet UL/cUL 60950, IEC/EN 60950-1					
Feature Characteristics					
Fixed Switching Frequency			200		kHz
	Input Current and Output Voltage Ripple		400		kHz
Output Voltage Trim Range	Adjustable via TRIM (Pin 12)	60		110	%
Remote Sense Compensation	Between SENSE+ and +OUT pins			1	V
Output Overvoltage Protection	Non-latching	114	122	130	%
Overtemperature Shutdown (Baseplate)	Non-latching (Vin=9V; 12V, 24/36V)	108	112	115	°C
Auto-Restart Period	Applies to all protection features	1.7	2	2.3	S
Turn-On Delay Time from Vin	Time from UVLO to Vo=90%VOUT(NOM) Resistive load	480	517	530	ms
Turn-On Delay Time from ON/OFF Control (From ON to 90%VOUT(NOM) Resistive load)	24S12.84FXT	15	22	30	ms
	24S24.42FXT & 24S28.36FXT	20	27	35	ms
	24S48.21FXT & 24S53.19FXT	20	35	50	ms
Rise Time (Vout from 10% to 90%)	24S12.84FXT, 24S24.42FXT, 24S28.36FXT	4	7	11	ms
	24S48.21FXT & 24S53.19FXT	7	15	25	ms
ON/OFF Control – Positive Logic					
ON state	Pin open = ON or	2		12	V
Control Current	Leakage current			0.16	mA
OFF state		0		0.8	V
Control current	Sinking	0.3		0.36	mA
ON/OFF Control – Negative Logic					
ON state	Pin shorted to – ON/OFF pin or	0		0.8	V
OFF state	Pin open = OFF or	2		12	V
Thermal Characteristics					
Thermal resistance Baseplate to Ambient	Converter soldered to 5" x 3.5" x 0.07", 4 layers/ 20z copper FR4 PCB.		3.3		°C/W



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Electrical Specifications (continued)

Conditions: TA = 25 °C, Airflow = 300 LFM (1.5 m/s) and 0.9" heatsink, Vin = 14VDC, unless otherwise specified. Specifications are subject to change without notice.

24S12.84FXT					
Parameter	Notes	Min.	Typ.	Max.	Units
Input Characteristics					
Operating Input Voltage Range		9	14	36	V
Input Under Voltage Lockout	Non-latching				
Turn-on Threshold		8.2	8.5	8.8	V
Turn-off Threshold		7.7	8.0	8.3	V
Lockout Hysteresis Voltage		0.4	0.55	0.7	V
Maximum Input Current	Vin = 9V, 80% Load			89	A
	Vin = 12V, 100% Load			92	A
	Vin = 14V, Output Shorted		600		mARMS
Input Stand-by Current	Converter Disabled		2	4	mA
Input Current @ No Load	Converter Enabled	450	550	690	mA
Minimum Input Capacitance (external) 1)	See Table 1	1000			µF
Inrush Transient				0.19	A2s
Inrush Transient Input Terminal Ripple Current, iC	25 MHz bandwidth, 100% Load (Fig. 2)		3.65		ARMS
Output Characteristics					
Output Voltage Range		11.64	12.00	12.36	V
Output Voltage Set Point Accuracy	(No load)	11.90	12.00	12.10	V
Output Regulation					
Over Line	Vin = 9V to 36V		0.05	0.10	%
Over Load	Vin = 14V, Load 0% to 100%		0.05	0.150	%
Temperature Coefficient			0.005	0.015	%/°C
Overvoltage Protection		14		15.6	V
Output Ripple and Noise – 20 MHz bandwidth	100% Load (see Table 1 for external components)		120		mVPK-PK
			40		mVrms
External Load Capacitance ¹	See Table 1				
Output Current Range (see Figure 1)	Vin = 12V – 36V	0		84	A
	Vin = 9V	0		67.2	A
Current Limit Inception	Vin = 12V – 36V	92.4	100.8	109.2	A
	9V ≤ Vin < 12V	73.5		109.2	A
RMS Short-Circuit Current	Non-latching, Continuous		7		Arms
Dynamic Response					
Load Change 50%-100%-50%, di/dt = 0.5A/µs	See Table 1 for external capacitors		±500		mV
Settling Time to 1% of VOUT			800		µs
Efficiency					
100% Load	Vin = 14V		93.0		%
	Vin = 12V		92.3		%
50% Load	Vin = 14V		95.4		%
	Vin = 12V		95.0		%

¹ Section "Input and Output Capacitance"



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Electrical Specifications (continued)

Conditions: TA = 25 °C, Airflow = 300 LFM (1.5 m/s) and 0.9" heatsink, Vin = 14VDC, unless otherwise specified. Specifications are subject to change without notice.

24S24.42FXT					
Parameter	Notes	Min.	Typ.	Max.	Units
Input Characteristics					
Operating Input Voltage Range		9	24	36	V
Input Under Voltage Lockout	Non-latching				
Turn-on Threshold		8.2	8.5	8.8	V
Turn-off Threshold		7.7	8.0	8.3	V
Lockout Hysteresis Voltage		0.4	0.55	0.7	V
Maximum Input Current	Vin = 9V, 80% Load			89	A
	Vin = 12V, 100% Load			92	A
	Vin = 24V, Output Shorted		350		mARMS
Input Stand-by Current	Converter Disabled		2		mA
Input Current @ No Load	Converter Enabled	330	420	530	mA
Minimum Input Capacitance (external)1)	ESR < 0.1 Ω	1000			μF
Inrush Transient				0.19	A2s
Input Terminal Ripple Current, iC	25 MHz bandwidth, 100% Load (Fig. 5)		3.65		ARMS
Output Characteristics					
Output Voltage Range		23.62	24.00	24.36	V
Output Voltage Set Point Accuracy	(No load)	23.90	24.00	24.10	V
Output Regulation					
Over Line	Vin = 9V to 36V		0.05	0.10	%
Over Load	Vin = 24V, Load 0% to 100%		0.05	0.10	%
Temperature Coefficient			0.005	0.015	%/°C
Overvoltage Protection		27.36		31.2	V
Output Ripple and Noise – 20 MHz bandwidth	100% Load (see Table 1 for external components)		200	320	mVPK-PK
			50	80	mVrms
External Load Capacitance1)	Full Load (resistive) (over operating temp range)	CEXT ESR	1000	100	μF mΩ
			10	100	
Output Current Range (see Figure 1)	Vin = 12V – 36V	0		42	A
	Vin = 9V	0		33.5	A
Current Limit Inception	Vin = 12V – 36V	46	50.2	54.6	A
	9V ≤ Vin < 12V	37	49	54.6	A
RMS Short-Circuit Current	Non-latching, Continuous	2.0		6.5	Arms
Dynamic Response					
Load Change 50%-75%-50%, di/dt = 1A/μs	Co = 2 x 470 μF/70mΩ		± 400	± 600	mV
Load Change 50%-100%-50%, di/dt = 1A/μs	Co = 2 x 470 μF/70mΩ		±700		mV
Settling Time to 1% of VOUT			500		μs
Efficiency					
100% Load	Vin = 24V	93.6	94.6	95.3	%
	Vin = 12V	92.4	93.4	94	%
50% Load	Vin = 24V	95.0	96	96.4	%
	Vin = 12V	94.7	95.7	96.3	%



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24S28.36FXT

Parameter	Notes	Min.	Typ.	Max.	Units
Input Characteristics					
Operating Input Voltage Range		9	24	36	V
Input Under Voltage Lockout	Non-latching				
Turn-on Threshold		8.2	8.5	8.8	V
Turn-off Threshold		7.7	8.0	8.3	V
Lockout Hysteresis Voltage		0.4	0.55	0.7	V
Maximum Input Current	V _{in} = 9V, 80% Load			89	A
	V _{in} = 12V, 100% Load			92	A
	V _{in} = 24V, Output Shorted		330		mA _{RMS}
Input Stand-by Current	Converter Disabled		2	4	mA
Input Current @ No Load	Converter Enabled	400	480	600	mA
Minimum Input Capacitance (external) ₁₎	ESR < 0.1 Ω	1000			μF
Inrush Transient				0.19	A ₂ S
Input Terminal Ripple Current, i _c	25 MHz bandwidth, 100% Load (Fig. 6)		2.5		A _{RMS}
Output Characteristics					
Output Voltage Range		27.56	28.00	28.42	V
Output Voltage Set Point Accuracy	(No load)	27.9	28.00	28.1	V
Output Regulation					
Over Line	V _{in} = 9V to 36V		0.05	0.10	%
Over Load	V _{in} = 24V, Load 0% to 100%		0.05	0.10	%
Temperature Coefficient			0.005	0.015	%/°C
Overvoltage Protection		31.9		36.4	V
Output Ripple and Noise – 20 MHz bandwidth	100% Load (see Table 1 for external components)		220	360	mV _{PK-PK}
			50	80	mV _{RMS}
External Load Capacitance ₁₎	Full Load (resistive) (over operating temp range)	C _{EXT} ESR	1000	4700	μF mΩ
			10	100	
Output Current Range (see Figure 1)	V _{in} = 12V – 36V	0		36	A
	V _{in} = 9V	0		28.8	A
Current Limit Inception	V _{in} = 12V – 36V	39.6	50.2	46.8	A
	9V ≤ V _{in} < 12V	31.7	49	46.8	A
RMS Short-Circuit Current	Non-latching	1.7		6.4	Arms
Dynamic Response					
Load Change 50%-75%-50%, di/dt = 1A/μs	See Table 1 for external components		± 330	± 430	mV
Load Change 50%-100%-50%, di/dt = 1A/μs	See Table 1 for external components		±600		mV
Settling Time to 1% of VOUT			500		μs
Efficiency					
100% Load	V _{in} = 24V	94.5	95.5	96.2	%
	V _{in} = 12V	93.0	93.8	94.5	%
50% Load	V _{in} = 24V	95.5	96.2	97	%
	V _{in} = 12V	94.3	95.4	96.2	%



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24S48.21FXT

Parameter	Notes	Min.	Typ.	Max.	Units	
Input Characteristics						
Operating Input Voltage Range		9	24	36	V	
Input Under Voltage Lockout	Non-latching					
Turn-on Threshold		8.2	8.5	8.8	V	
Turn-off Threshold		7.7	8.0	8.3	V	
Lockout Hysteresis Voltage		0.4	0.55	0.7	V	
Maximum Input Current	V _{in} = 9V, 80% Load			89	A	
	V _{in} = 12V, 100% Load			92	A	
	V _{in} = 24V, Output Shorted		400		mA _{RMS}	
Input Stand-by Current	Converter Disabled		2	4	mA	
Input Current @ No Load	Converter Enabled	370	470	560	mA	
Minimum Input Capacitance (external) ₁₎	ESR < 0.1 Ω	1000			μF	
Inrush Transient				0.19	A ₂ S	
Input Terminal Ripple Current, i _c	25 MHz bandwidth, 100% Load (Fig. 6)		0.9		A _{RMS}	
Output Characteristics						
Output Voltage Range		47.28	48.00	48.92	V	
Output Voltage Set Point Accuracy	(No load)	47.80	48.00	48.20	V	
Output Regulation						
Over Line	V _{in} = 9V to 36V		0.05	0.10	%	
Over Load	V _{in} = 24V, Load 0% to 100%		0.05	0.10	%	
Temperature Coefficient			0.005	0.015	%/°C	
Overvoltage Protection		54.7			V	
Output Ripple and Noise – 20 MHz bandwidth	100% Load, See Table 1 for external components		100	150	mV _{PK-PK}	
			25	50	mV _{RMS}	
External Load Capacitance ₁₎	Full Load (resistive) (over operating temp range)	C _{EXT} ESR	470		3000	μF mΩ
			10		100	
Output Current Range (see Figure 1)	V _{in} = 12V – 36V	0		21	A	
	V _{in} = 9V	0		16.8	A	
Current Limit Inception	V _{in} = 12V – 36V	23.1	25.2	27.3	A	
	9V ≤ V _{in} < 12V	18.48	20.16	27.3	A	
RMS Short-Circuit Current	Non-latching	1.0	1.6	3.3	A _{RMS}	
Dynamic Response						
Load Change 50%-75%-50%, di/dt = 1A/μs	See Table 1 for external components		± 480	± 560	mV	
Load Change 50%-100%-50%, di/dt = 1A/μs	See Table 1 for external components		± 880	± 1150	mV	
Settling Time to 1% of V _{OUT}			500		μs	
Efficiency						
100% Load	V _{in} = 24V	94.3	95.0	95.7	%	
	V _{in} = 12V	93.2	93.9	94.6	%	
50% Load	V _{in} = 24V	95.3	96	96.7	%	
	V _{in} = 12V	94.9	95.6	96.3	%	



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Electrical Specifications (continued)

Conditions: TA = 25 °C, Airflow = 300 LFM (1.5 m/s), Vin = 24VDC, unless otherwise specified. Specifications are subject to change without notice.

24S53.19FXT					
Parameter	Notes	Min.	Typ.	Max.	Units
Input Characteristics					
Operating Input Voltage Range		9	24	36	V
Input Under Voltage Lockout	Non-latching				
Turn-on Threshold		8.2	8.5	8.8	V
Turn-off Threshold		7.7	8.0	8.3	V
Lockout Hysteresis Voltage		0.4	0.55	0.7	V
Maximum Input Current	Vin = 9V, 80% Load			89	A
	Vin = 12V, 100% Load			92	A
	Vin = 24V, Output Shorted		300		mA _{RMS}
Input Stand-by Current	Converter Disabled		2	4	mA
Input Current @ No Load	Converter Enabled	360	460	560	mA
Minimum Input Capacitance (external) ₁₎	ESR < 0.1 Ω	1000			μF
Inrush Transient				0.19	A _{2S}
Input Terminal Ripple Current, ic	25 MHz bandwidth, 100% Load (Fig. 6)		0.8		A _{RMS}
Output Characteristics					
Output Voltage Range		52.20	53.00	54.02	V
Output Voltage Set Point Accuracy	(No load)	52.780	53.00	53.220	V
Output Regulation					
Over Line	Vin = 9V to 36V		0.05	0.10	%
Over Load	Vin = 24V, Load 0% to 100%		0.05	0.10	%
Temperature Coefficient			0.005	0.015	%/°C
Overvoltage Protection		60.4	64.7	69.4	V
Output Ripple and Noise – 20 MHz bandwidth	100% Load, See Table 1 for external components		70	140	mV _{PK-PK}
			16	50	mV _{RMS}
External Load Capacitance ₁₎	Full Load (resistive) (over operating temp range)	C _{EXT} ESR	470	2200	μF mΩ
			10	100	
Output Current Range (see Figure 1)	Vin = 12V – 36V	0		19	A
	Vin = 9V	0		15.2	A
Current Limit Inception	Vin = 12V – 36V	20.9	22.8	24.7	A
	9V ≤ Vin < 12V	16.7	18.2	24.7	A
RMS Short-Circuit Current	Non-latching	0.8	1.8	3.0	A _{RMS}
Dynamic Response					
Load Change 50%-75%-50%, di/dt = 1A/μs	See Table 1 for external components		± 420	± 510	mV
Load Change 50%-100%-50%, di/dt = 1A/μs	See Table 1 for external components		± 850	± 1100	mV
Settling Time to 1% of VOUT			500		μs
Efficiency					
100% Load	Vin = 24V	94.9	95.7	96.4	%
	Vin = 12V	93.4	94.1	95	%
50% Load	Vin = 24V	95.3	96.2	96.9	%
	Vin = 12V	95.1	95.4	96.5	%



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Environmental and Mechanical Specifications:

Specifications are subject to change without notice.

Parameter	Notes	Min	Typ	Max	Units
Environmental					
Operating Humidity	Condensing			95	%
Storage Humidity	Condensing			95	%
ROHS Compliance 1	See Calex Website http://www.calex.com/RoHS.html for the complete RoHS Compliance statement.				
Shock and Vibration	Designed to meet MIL-STD-810G for functional shock and vibration.				
Water washability	Not recommended for water wash process. Contact the factory for more information.				
Mechanical					
Weight			8.55		Ounces
			242		Grams
Through Hole Pins Diameters	Pins 1, 2, 10, 11 and 12	0.038	0.04	0.042	Inches
		0.965	1.016	1.067	mm
Through Hole Pins Material	Pins 1, 2, 10, 11 and 12	Brass Alloy TB3 or "Eco Brass)			
Through Hole Pin Finish	All pins	10 micro inches Gold over nickel			
Terminal Blocks	Terminal Blocks 3 and 4	0.425L x 0.200W x 0.243H			Inches
		10.795L x 5.08Wx 6.172H			mm
Terminal Blocks	Terminal Blocks 5 and 8	0.375L x 0.200W x 0.243H			Inches
		10.795L x 5.08Wx 6.172H			mm
Terminal Block Material	Terminal Blocks 3, 4, 5 and 8	CuZn39Pb3 or C2680 Brass			
Terminal Block Finish	Terminal Blocks 3, 4, 5 and 8	20 micro inches Gold over nickel			
Case Dimension		4.7 x 2.5 x 0.52			Inches
		119.38 x 63.50 x 13.21			mm
Case Material	Plastic: Vectra LCP FIT30: ½-16 EDM Finish				
Baseplate	Material	Aluminum			
	Flatness		0.010		Inches
			0.25		mm
Reliability					
MTBF	Telcordia SR-332, Method I Case 1 50% electrical stress, 40°C components		5.4		MHrs

Note: The RoHS marking is as follows:

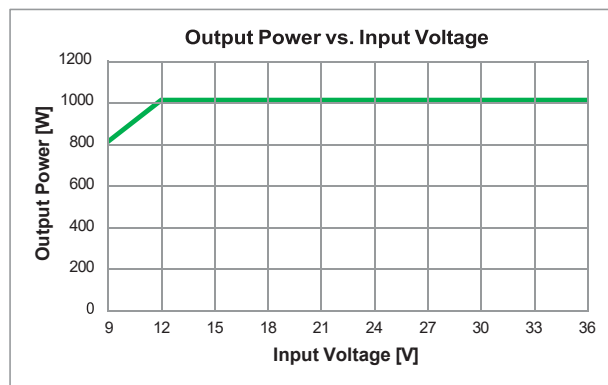


Figure 1: Output Power as a Function of Input Voltage



Operations

Input Fusing

The FXT converters do not provide internal fusing and therefore in some applications, external input fuse might be required. Use of external fuse is also recommended if there is possibility for input voltage reversal. For optimal safety, it is recommended to use fast blow fuse in the ungrounded input supply line.

Input Reverse Polarity Protection

The FXT converters do not have input reverse polarity. If input voltage polarity is reversed, internal diodes become forward biased and draw excessive current from the power source. If the power source is not current limited or input fuse not used, the converter could be permanently damaged.

Input Undervoltage Protection

Input undervoltage lockout is standard with this converter. The FXT converter starts and regulates properly if the ramping-up input voltage exceeds, Turn-on threshold of typ.8.5V (see Specification), and remains at or above Turn-on Threshold.

The converter turns off when the input voltage drops below the Turn-off Threshold of typical 8V (see specification) and the converter enters hiccup mode and stays off for two seconds. The converter restarts after two seconds only if the input voltage is again above the Turn- on Threshold.

The built-on hysteresis and two-second hiccup time prevents any unstable on/off operation at the low input voltage near Turn-on Threshold.

Consider the IR and inductive voltage drop in the input source and input power lines. Ensure that the input voltage to the converter is always above the Turn-off Threshold voltage under all operating conditions.

Start-Up Time

The start-up time is specified under two different scenarios: a) Startup by ON/OFF remote control (with the input voltage above the Turn-on Threshold voltage) and b) Start-up by applying the input voltage (with the converter enabled via ON/OFF remote control).

The startup times are measured with maximum resistive load as: a) the interval between the point when the ramping input voltage crosses the Turn-on Threshold and the output voltage reaches 90% of its nominal value and b) the interval between the point when the converter is enabled by ON/OFF remote control and time when the output voltage reaches 90% of its nominal value.

When converter is started by applying the input voltage with ON/OFF pin active there is delay of 500msec that was intentionally provided to prevent potential startup issues especially at low input voltages

Input Source Impedance

Because of the switching nature and negative input impedance of DC/DC converters, the input of these converters must be driven from the source with both low AC impedance and DC input regulation.

The FXT converters are designed to operate without external components if the source voltage has very low impedance and reasonable voltage regulation. However, since this is not the case in most applications an additional input capacitor is required to provide proper operations of the FXT converter. Specified values for input capacitor are recommendation and need to be adjusted for particular application. Due to large variation between applications some experimentation might be needed.

In many applications, the inductance associated with the distribution from the power source to the input of the converter can affect the stability. If excessive, it can inhibit operation of the converter. This becomes a consideration for input voltage at 12V or below.

The DC input regulation, associated with resistance between input power source and input of the converter, plays significant role in particular in low input voltage applications such as 12V battery systems.

Note that input voltage at the input pins of the connector must never degrade below Turn-off threshold under all load operating conditions.

Note that in applications with high pulsating loads additional input as well as output capacitors might be needed. In addition, for EMI conducted measurement, due to low input voltage it is recommended to use 5 μ H LISNs.

Input/ Output Filtering

Input Capacitor

Minimum required input capacitance, mounted close to the input pins of the converter, is 1000 μ F with ESR < 0.1 Ω .

Several criteria need to be met when choosing input capacitor: a) type of capacitor, b) capacitance to provide additional energy storage, c) RMS current rating, d) ESR value that will ensure that output impedance of the input filter is lower than input impedance of the converter and its variation over the temperature.

Since inductance of the input power cables could have significant voltage drop due to rate of change of input current $di(in)/dt$ during transient load operation, an external capacitor on the output of the converter is required to reduce $di(in)/dt$. Another constraint is minimum rms current rating of the input capacitors which is application dependent.

One component of input rms current handled by input capacitor is high frequency component at switching frequency of the converter (typ. 400kHz) and is specified under “Input terminal ripple current” i_C . Typical values at full rated load and 24 Vin are provided in Section “Characteristic Waveforms” for each model and are in range of 2.5A– 3.6A . It is recommended to use ceramic capacitors for attenuating this component for input terminal ripple current, which is also required to meet requirement for conducted EMI (see EMI Section).

The second component of the input ripple current is due to pulsating load current being reflected to the input and electrolytic capacitors usually used for this purpose need to be selected accordingly. Using several electrolytic capacitors in parallel on the input is recommended.

ESR of the electrolytic capacitors needs to be carefully chosen with consideration of temperature dependence.

Output Capacitor

Similar considerations apply for selecting external output capacitor. For additional high frequency noise attenuation, use of ceramic capacitors is recommended while to provide stability of the converter during high pulsating load high value electrolytic capacitor is required. It is recommended to use several electrolytic capacitors in parallel to reduce effective ESR. Note that external output capacitor also reduces slew rate of the input current during pulsating load transients as discussed above.

Table 1 shows recommended external output capacitance.

ON/OFF (Pins 1 and 2)

The ON/OFF pin is used to turn the power converter on or off remotely via a system signal and has positive logic. A typical connection for remote ON/OFF function is shown in Figure 2.

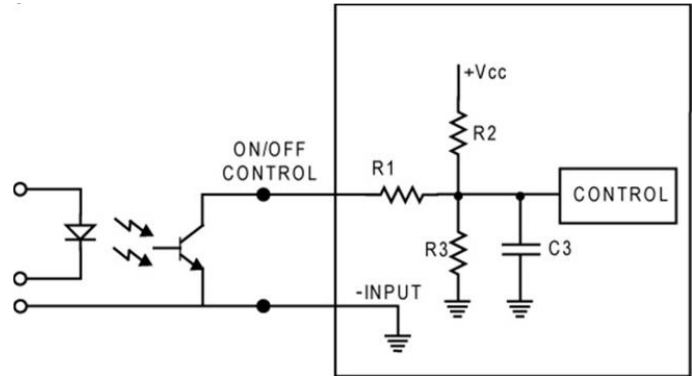


Figure 2: Circuit Configuration for ON/OFF Function

The positive logic version turns on when the ON/OFF pin is at logic high and turns off when at logic low. The converter is on when the ON/OFF pin is either left open or external voltage greater than 2V and not more than 12V is applied between ON/OFF pin and – INPUT pin. See the Electrical Specifications for logic high/low definitions.

The negative logic version turns on when the ON/OFF pin is at logic low and turns off when at logic high. The converter is on when the ON/OFF pin is either shorted to –INPUT pin or kept below 0.8V. The converter is off when the ON/OFF pin is either left open or external voltage not more than 12V is applied between ON/OFF pin and –INPUT pin. See the Electrical Specifications for logic high/ low definitions.

The ON/OFF pin is internally pulled up to typically 4.5V via resistor and connected to internal logic circuit via RC circuit in order to filter out noise that can occur on the ON/OFF pin. A properly de-bounced mechanical switch, open-collector transistor, or FET can be used to drive the input of the ON/OFF pin. The device must be capable of sinking up to 0.36mA at a low-level voltage of 0.8 V. During logic high, the typical maximum voltage at ON/OFF pin (generated by the converter) is 4.5V, and the maximum allowable leakage current is 160 μ A. If not using the remote on/off feature, leave the ON/OFF pin open.

TTL Logic Level - The range between 0.81V and 2V is considered the dead-band. Operation in the dead-band is not recommended.

External voltage for ON/OFF control should not be applied when there is no input power voltage applied to the converter.

Output Overcurrent Protection (OCP)

The converter is protected against overcurrent or short circuit conditions. Upon sensing an overcurrent condition, the converter will switch to constant current operation and thereby begin to reduce output voltage. When the output voltage drops below approx. 50% of the nominal value of output voltage, the converter will shut down.

Once the converter has shut down, it will attempt to restart nominally every 2 seconds. The attempted restart will continue indefinitely until the overload or short circuit conditions are removed or the output voltage rises above 50% of its nominal value.

Once the output current is brought back into its specified range, the converter automatically exits the hiccup mode and continues normal operation.

During initial startup if output voltage does not exceed typical 50% of nominal output voltage within 500 msec after the converter is enabled, the converter will be shut down and will attempt to restart after two seconds.

In case of startup into short circuit, internal logic detects short circuit condition and shuts down converter typical 5 msec after condition is detected. The converter will attempt to restart after 2 seconds until short circuit condition exists.

Output Overvoltage Protection(OVP)

The converter will shut down if the output voltage across +OUT (Pins 5 and 6) and -OUT (Pins 8 and 9) exceeds the threshold of the OVP circuitry. The OVP circuitry contains its own reference, independent of the output voltage regulation loop. Once the converter has shut down, it will attempt to restart every two seconds until the OVP condition is removed.

Note that OVP threshold is set for nominal output voltage and not trimmed output voltage value or remote sense voltage.

Overtemperature Protection (OTP)

The FXT converters have non-latching overtemperature protection. It will shut down and disable the output if temperature at the center of the base plate exceeds a threshold of typical 108°C for 9Vin, 112 °C for 12Vin and 115 °C for 24Vin/36Vin. Measured with FXT converter soldered to 5" x 3.5" x 0.07" 4 layers/ 2 Oz Cooper FR4 PCB.

The converter automatically restarts when the base temperature has decreased by approximately 20°C.

Safety Requirements

Basic Insulation is provided between input and the output. The converters have no internal fuse. To comply with safety agency requirements, a fast-acting or time-delay fuse is to be provided in the unearthed lead. Recommended fuse values are:

- 140A for 9V<Vin<18V
- 90A for 18V<Vin<36V

Electromagnetic Compatibility (EMC)

EMC requirements must be met at the end-product system level, as no specific standards dedicated to EMC characteristics of board mounted component dc-dc converters exist.

With the addition of a two-stage external filter, the FXT converters will pass the requirements of MILSTD-461F CE102 Base Curve for conducted emissions. Note that 5uH LISN should be used to enable operation of the converter at low input voltage.

Remote Sense Pins (Pins 10 and 11)

Sense inputs compensate for output voltage inaccuracy delivered at the load.

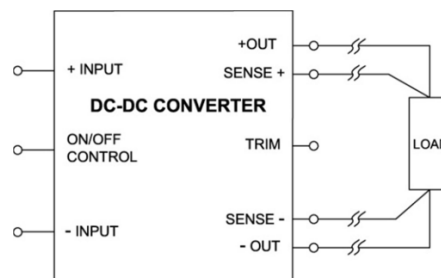


Figure 3: Circuit Configuration for Remote Sense Function



The sense input and power Vout pins are internally connected through 100Ω (SENSE+ to +OUT) and 10 Ω (SENSE- to -OUT) resistors enabling the converter to operate without external connection to the Sense. If the Sense function is not used for remote regulation, the user should connect SENSE- (Pin 10) to -OUT (Pins 8 and 9) and SENSE+ (Pin 11) to +OUT (Pins 5 and 6) at the converter pins.

Sense lines must be treated with care in PCB layouts and should run adjacent to DC signals. If cables and discrete wiring is used, it is recommended to use twisted pair, shielded tubing or similar techniques. The maximum voltage difference between Sense inputs and corresponding power pins should be kept below 1V, i.:

$$V(\text{SENSE+}) - V(+\text{OUT}) \leq 1V \quad V(-\text{OUT}) - V(\text{SENSE-}) \leq 1V$$

Note that maximum output power is determined by maximum output current and highest output voltage at the output pins of the converter:

$$[V(+\text{OUT}) - V(-\text{OUT})] \times I_{\text{out}} \leq P_{\text{out rated}}$$

Output Voltage Adjust/TRIM (Pin 12)

The TRIM (Pin 12) allows user to adjust output voltage 10% up or -40% down relative to rated nominal voltage by addition of external trim resistor. Trim resistor should be mounted close to the converter and connected with short leads. Internal resistor in the converter used for the TRIM is high precision 0.1% with temperature coefficient 25 ppm/ °C. The accuracy of the TRIM is therefore determined by tolerance of an external Trim resistor. If trimming is not used, the TRIM pin should be left open.

Trim Down – Decrease Output Voltage

Trimming down is accomplished by connecting an external resistor, $R_{\text{TRIM-DOWN}}$, between the TRIM (pin 7) and the Vout- (pin 9), using A Kelvin connection with a value of:

$$R_{\text{TRIM-DOWN}} = \left(\frac{3010}{\Delta} - 60.2 \right) = [k\Omega]$$

where,

$R_{\text{trim-down}}$ = Required value of the trim-down resistor [kΩ]

$V_{\text{O(NOM)}}$ = Nominal value of output voltage [V]

$V_{\text{O(REQ)}}$ = Required value of output voltage [V]

$$\Delta = \left| \frac{V_{\text{O(req.)}} - V_{\text{O(nom.)}}}{V_{\text{O(nom.)}}} \right| [\%]$$

To trim the output voltage 10% ($\Delta=10$) down, required external trim resistance is:

$$R_{(\text{Trim-Down})} = \left(\frac{3010}{10} - 60.2 \right) = 240.8k\Omega$$

Trim Up – Increase Output Voltage

Trimming up is accomplished by connecting an external resistor, $R_{\text{TRIM-UP}}$, between the TRIM (pin 7) and the VOUT(+) (pin 5), with a value of:

$$R_{(\text{Trim-Up})} = 30.1 \times \left[\frac{V_{\text{O(nom.)}} \times (100 + \Delta)}{1.225 \times \Delta} - \frac{100 + 2\Delta}{\Delta} \right] [k\Omega]$$

To trim the output voltage up (for example 24V to 26.4V), $\Delta=10$ and required external resistor is:

$$R_{(\text{Trim-Up})} = 30.1 \times \left[\frac{24 \times (100 + 10)}{1.225 \times 10} - \frac{100 + (2 \times 10)}{10} \right] = 6125 [k\Omega]$$

Note that trimming output voltage more than 10% is not recommended and OVP might be tripped.

Active Voltage Programming

In applications where output voltage needs to be adjusted actively, an external voltage source, such as for example a Digital-to-Analog converter (DAC), capable of both sourcing and sinking current can be used. It should be connected across with series resistor R_g across TRIM (Pin 12) and SENSE- (Pin 10). External trim voltage should not be applied before the converter is enabled to provide proper startup output voltage waveform and prevent tripping overvoltage protection. Contact a Calex technical representative for more details.

Thermal Consideration

The FXT converter can operate in a variety of thermal environments. However, to ensure reliable operation of the converter, sufficient cooling should be provided. The FXT converter is encapsulated in a plastic case with a metal baseplate on the top. To improve thermal performance, power components inside the unit are thermally coupled to the baseplate. In addition, thermal design of the converter is enhanced by use of input and output pins as heat transfer elements. Heat is removed from the converter by conduction, convection, and radiation.



FXT Series 1,000 Watt

DC/DC Converters

There are several factors such as ambient temperature, airflow, converter power dissipation, converter orientation, how the converter is mounted as well as the need for increased reliability that need to be considered to achieve required performance. Murata Power Solutions recommends measuring temperature in the middle of the baseplate in particular application to ensure that proper cooling of the converter is provided. A reduction in the operating temperature of the converter results in increased reliability.

Thermal Derating

There are two most common applications: 1) the FXT converter is thermally attached to a cold plate inside chassis without any forced internal air circulation; 2) the FXT converter is mounted in an open chassis on system board with forced airflow with or without an additional heatsink attached to the base plate of the FXT converter.

The best thermal results are achieved in application 1) since the converter is cooled entirely by conduction of heat from the top surface of the converter to a cold plate and temperature of the components is determined by the temperature of the cold plate. There is also some additional heat removal through the converter's pins to the metal layers in the system board. It is highly recommended to solder pins to the system board rather than using receptacles. Typical derating output power and current are shown in Figures 17–26 for various baseplate temperatures up to 105°C. Note that operating converter at these limits for prolonged time will affect reliability.

Soldering Guidelines

The ROHS-compliant through-hole FXT converters use Sn/ Ag/Cu Pb-free solder and ROHS-compliant component. They are designed to be processed through wave soldering machines. The pins are gold over nickel plated and compatible with both Pb and Pb-free wave soldering processes. Murata Power Solutions recommends following these specifications when installing and soldering FXT converters. Exceeding these specifications can cause damage to the FXT converter.

FXT converters are not recommended for water wash process. Contact the factory for additional information if water wash is necessary.

Wave Solder Guideline For Sn/Ag/Cu based solders	
Maximum Preheat Temperature	115 °C
Maximum Pot Temperature	270 °C
Maximum Solder Dwell Time	7 seconds
Wave Solder Guideline For Sn/Pb based solders	
Maximum Preheat Temperature	105 °C
Maximum Pot Temperature	250 °C
Maximum Solder Dwell Time	6 seconds

Figure 4: Specifications for FXT Converters

Test Configuration

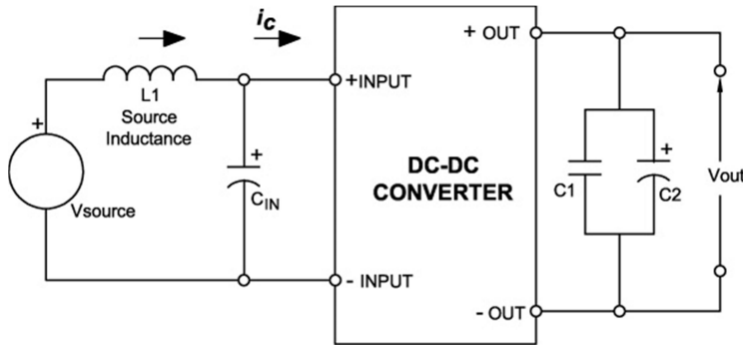


Figure 5: Test Setup for Measuring Input Reflected Ripple Currents i_c .

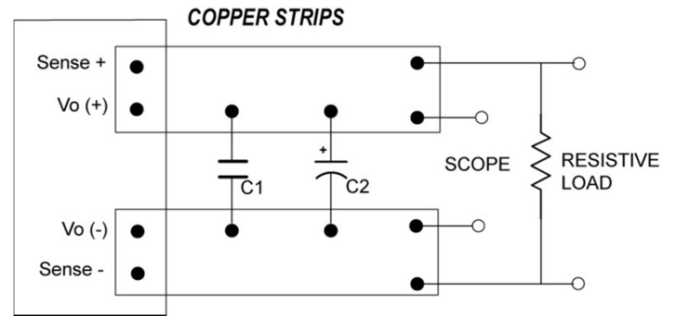


Figure 6: Test Setup for Measuring Output Voltage Ripple, Startup, and Step Load Transient Waveforms

Ref. Des.	Manufacturing p/n	24S12.84FXT	24S24.42FXT 24S28.36FXT	24S48.21FXT 24S53.19FXT
L1	N/A	6 ft. cable, AWG 4	100nH	100nH
C _{IN}	MAL214699108E3 (Vishay)	2 x 470 μ F / 72m Ω (650m Ω)	2 x 470 μ F / 72m Ω (650m Ω)	2 x 470 μ F / 76m Ω (650m Ω)
C1	GRM32ER72A475KA12L	10 μ F / 1210 / X7R / 100v	10 μ F / 1210/X7R/100V	10 μ F / 1210 / X7R / 100V
C2	PCR1E471MCL1GS	3 X 470 μ F / 25V / 15 m Ω (30 m Ω)	N/A	N/A
	PCR1J101MCL1GS (Nichicon)	N/A	3 x 100 μ F / 63V / 24 m Ω (48 m Ω)	N/A
	PCR1K680MCL1GS (Nichicon)	N/A	N/A	3 x 68 μ F / 80V / 28 m Ω (56 m Ω)
	UPS2A221MPD (Nichicon)	N/A	220 μ F / 100V / 100m Ω	220 μ F / 100V / 100m Ω
	MAL214699108E3 (Vishay)	N/A	470 μ F / 72m Ω (650m Ω)	N/A
	MAL214699606E3 (Vishay)	2 X 1500 μ F / 50m Ω (450m Ω)	N/A	N/A
	MAL214699608E3 (Vishay)	2200 μ F / 50m Ω (450m Ω)	N/A	N/A

Table 1: Component values used in test setup from Figures 5 and 6. Resistance in () represents ESR value at -40C for specified capacitor.

Characteristic Curves – Efficiency and Power Dissipation

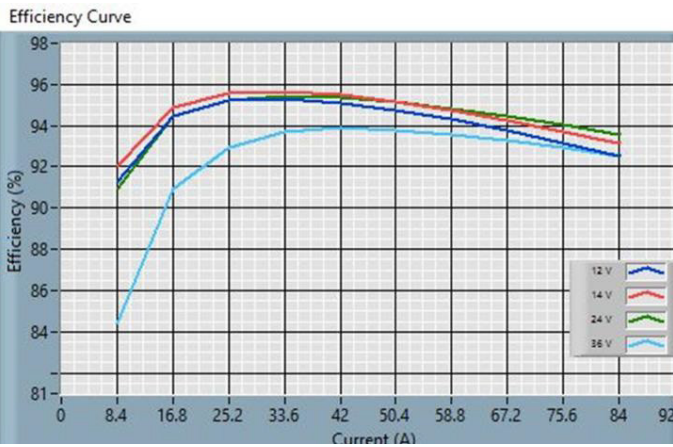


Figure 7: 24S12.84FXT (ROHS) Efficiency Curve

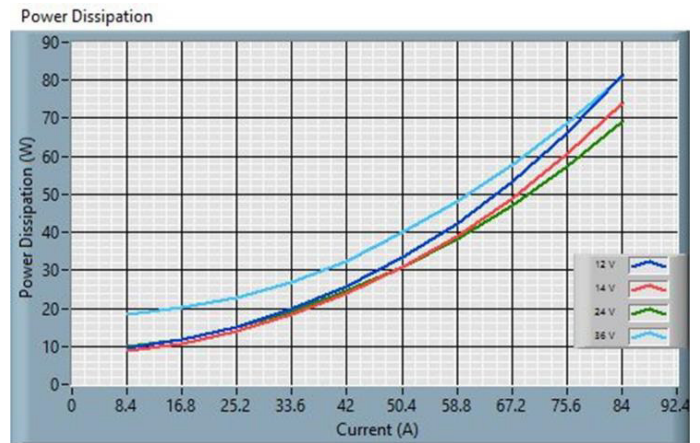


Figure 8: 24S12.84FXT (ROHS) Power Dissipation

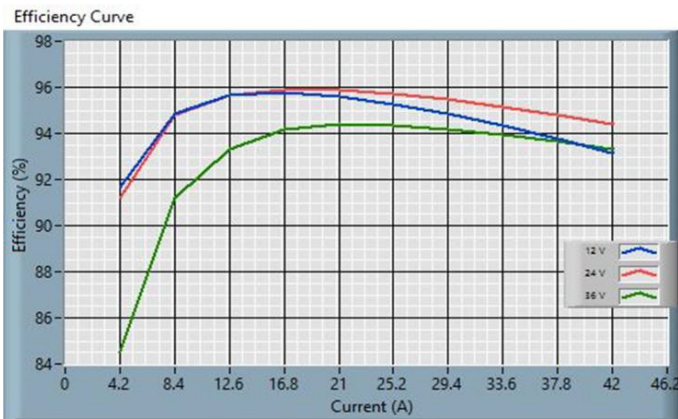


Figure 9: 24S24.42FXT (ROHS) Efficiency Curve

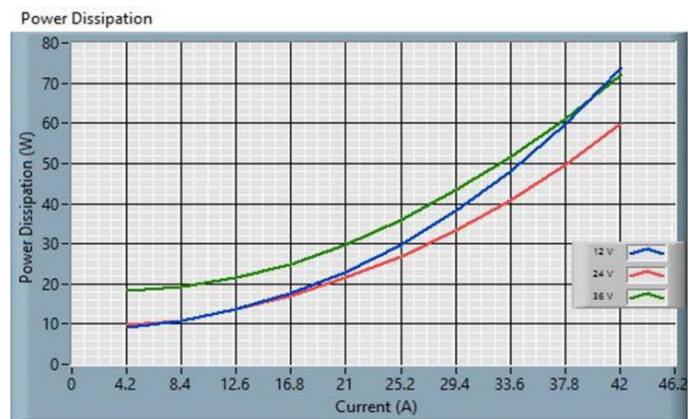


Figure 10: 24S24.42FXT (ROHS) Power Dissipation

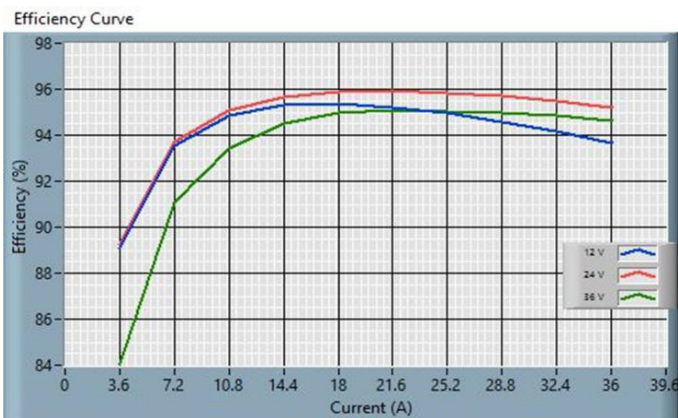


Figure 11: 24S28.36FXT (ROHS) Efficiency Curve

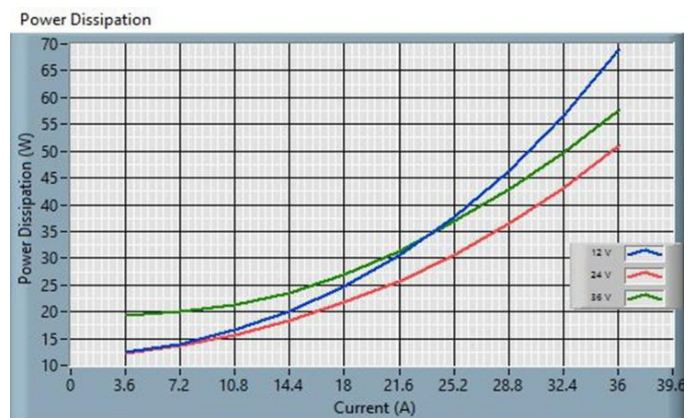


Figure 12: 24S28.36FXT (ROHS) Power Dissipation

Characteristic Curves – Efficiency and Power Dissipation (Cont'd)

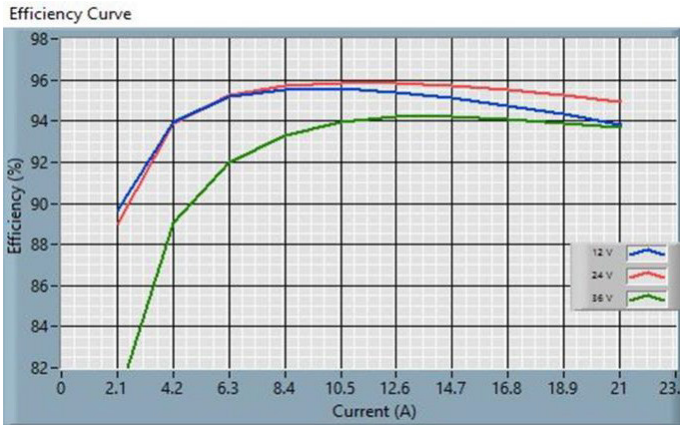


Figure 13: 24S48.21FXT (ROHS) Efficiency Curve

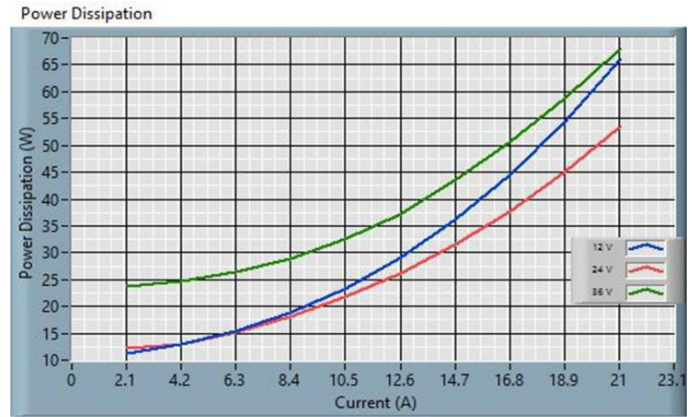


Figure 14: 24S48.21FXT (ROHS) Power Dissipation

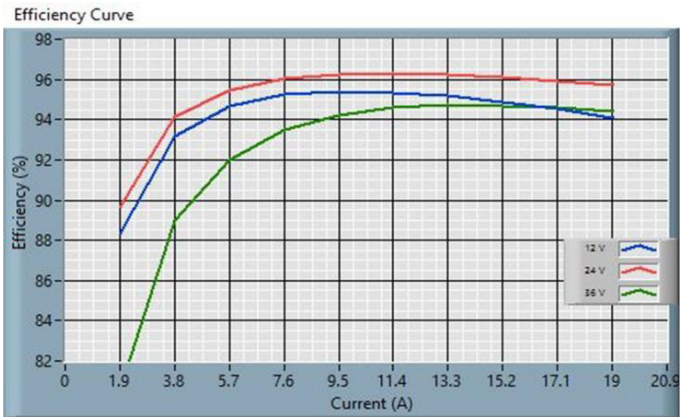


Figure 15: 24S53.19FXT (ROHS) Efficiency Curve

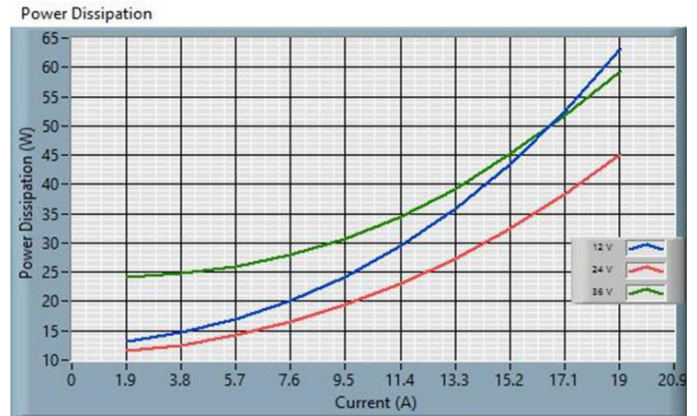


Figure 16: 24S53.19FXT (ROHS) Power Dissipation

Characteristic Curves – Derating Curves

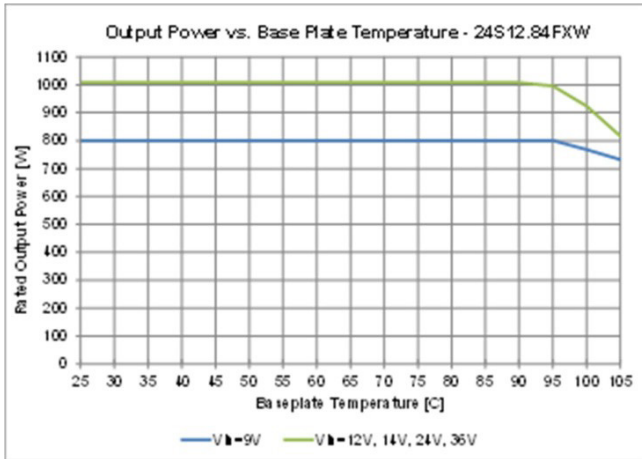


Figure 17: 24S12.84FXT (ROHS) Derating Curve

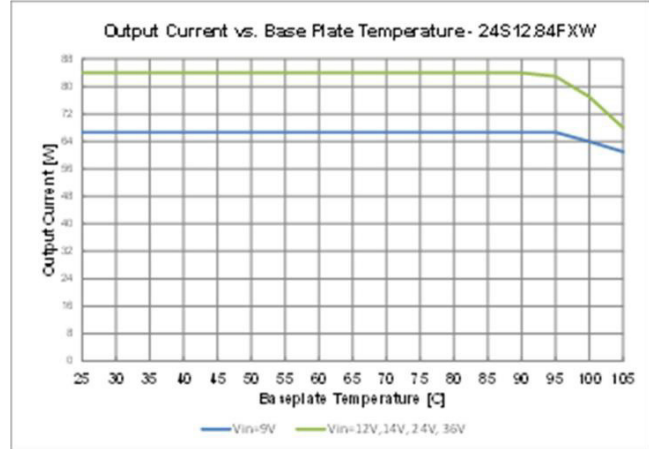


Figure 18: 24S12.84FXT (ROHS) Derating Curve

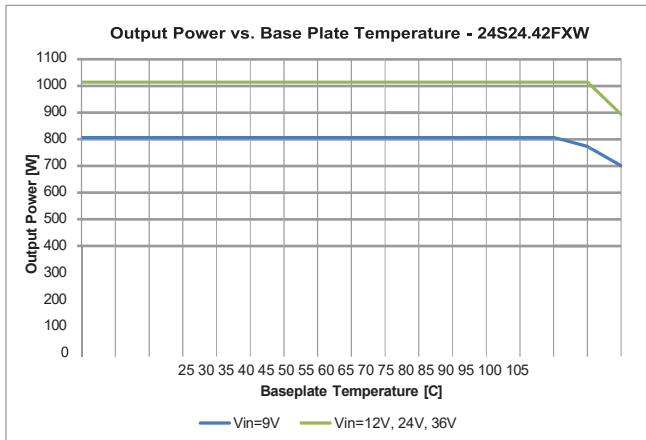


Figure 19: 24S24.42FXT (ROHS) Derating Curve

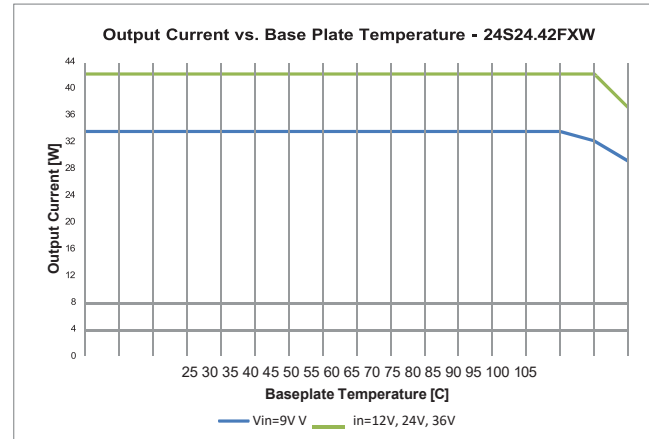


Figure 20: 24S24.42FXT (ROHS) Derating Curve

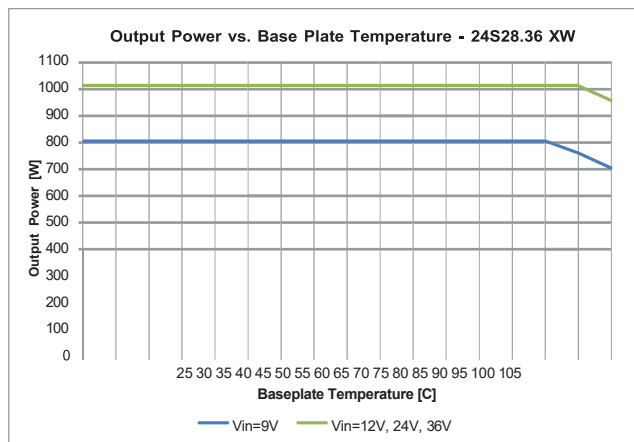


Figure 21: 24S28.36FXT (ROHS) Derating Curve

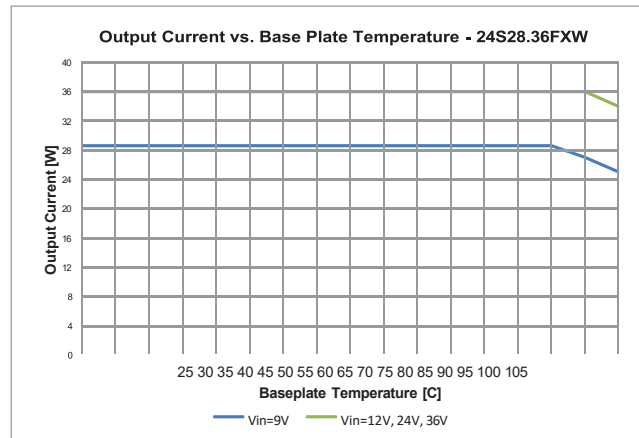


Figure 22: 24S28.36FXT (ROHS) Derating Curve

Characteristic Curves – Derating Curves (Cont'd)

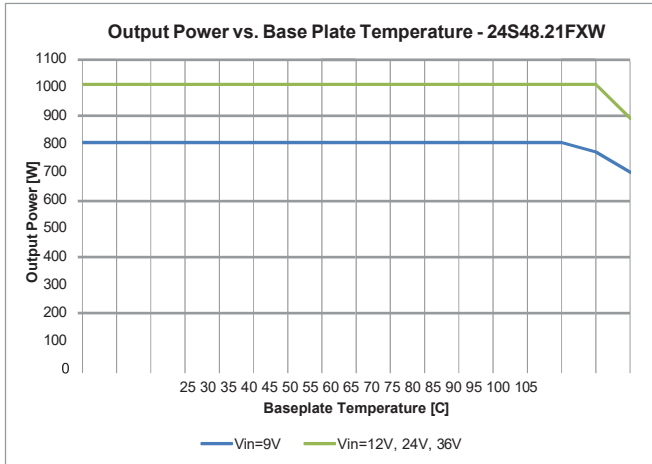


Figure 23: 24S48.21FXT (ROHS) Derating Curve

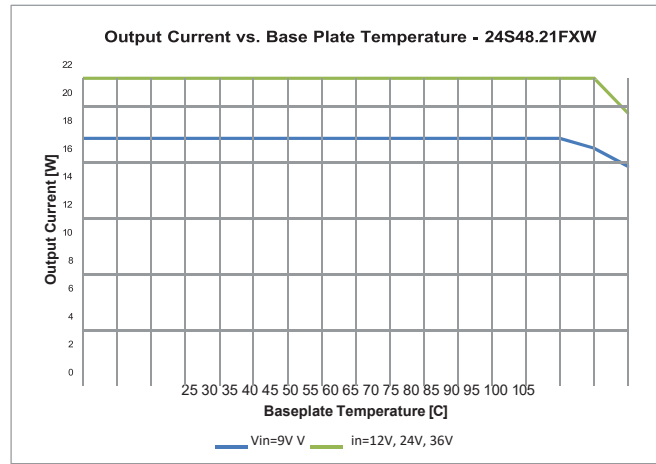


Figure 24: 24S48.21FXT (ROHS) Derating Curve

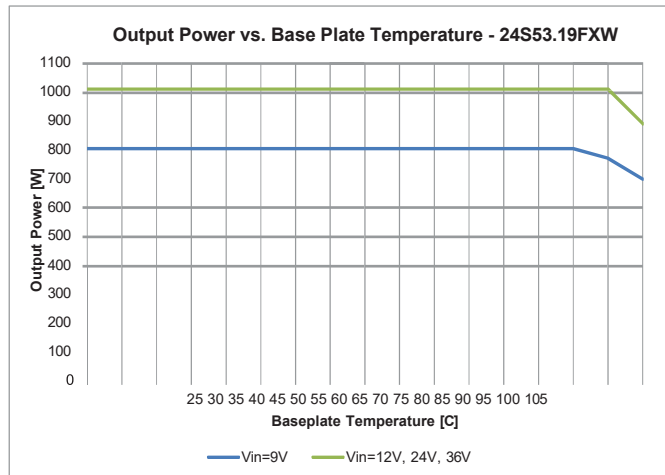


Figure 25: 24S53.19FXT (ROHS) Derating Curve

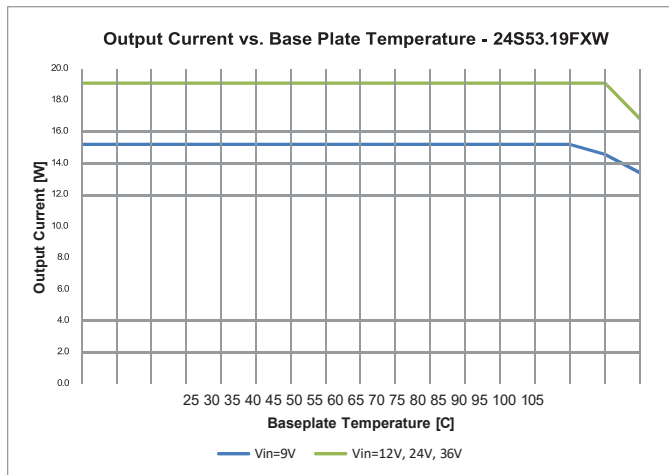


Figure 26: 24S53.19FXT (ROHS) Derating Curve

Characteristic Waveforms – 24S12.84FXT

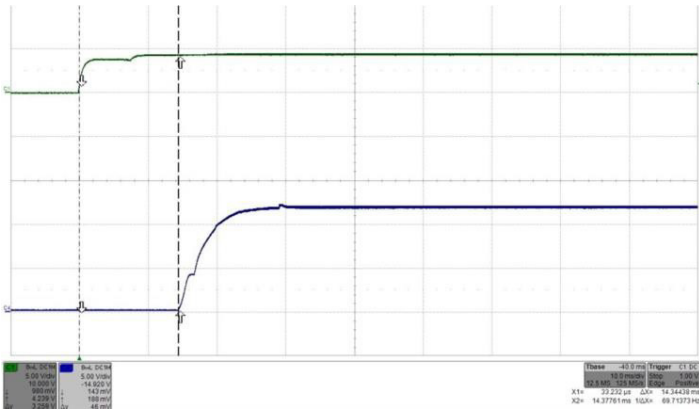


Fig. 27: Turn-on by ON/OFF transient (with Vin applied) at full rated load current (resistive) at Vin = 14V. Top trace (C1): ON/OFF signal (5 V/div.). Bottom trace (C4): Output voltage (5 V/div.). Time: 10 ms/div.

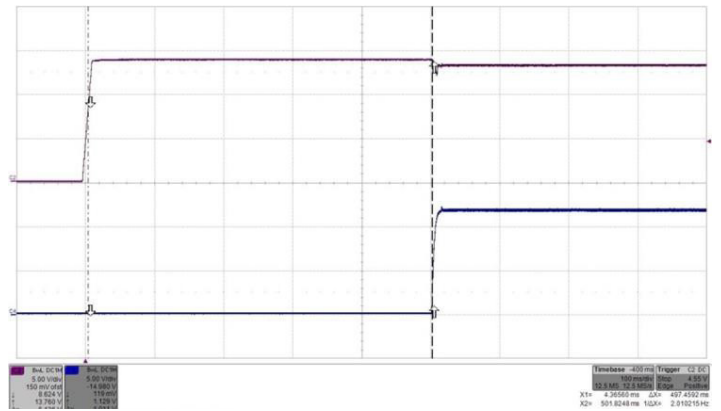


Fig. 28: Turn-on by Vin transient (ON/OFF high) at full rated load current (resistive) at Vin = 44V. Top trace (C2): Input voltage Vin (5 V/div.). Bottom trace (C4): Output voltage (5 V/div.). Time: 100 ms/div.

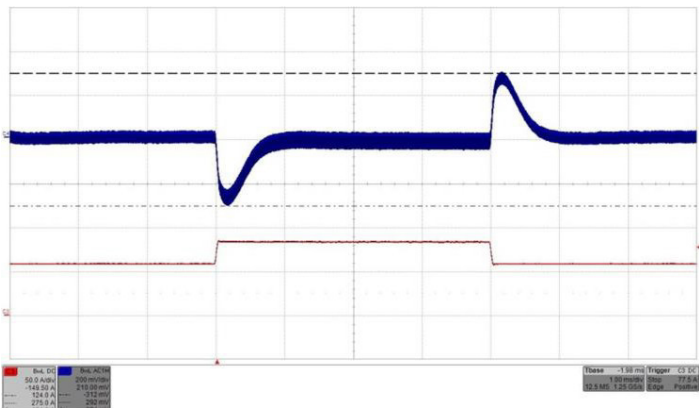


Fig. 29: Output voltage response to load current step change 70% - 100% - 70% (58.5A-84A-58.8A) with $di/dt = 0.5A/\mu s$ at Vin = 14V. Top trace (C4): Output voltage (200 mV/div.). Bottom trace (C3): Load current (50A/div.). Time: 1 ms/div.

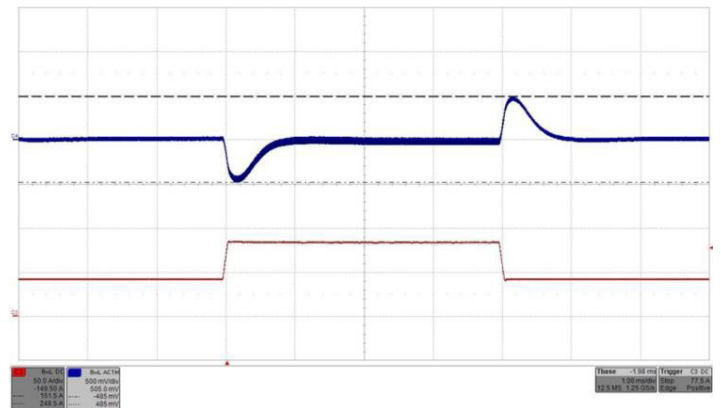


Fig. 30: Output voltage response to load current step change 50% - 100% - 50% (42A-84A-42A) with $di/dt = 1A/\mu s$ at Vin = 14V. Top trace (C4): Output voltage (500 mV/div.). Bottom trace (C3): Load current (50A/div.). Time: 1 ms/div.

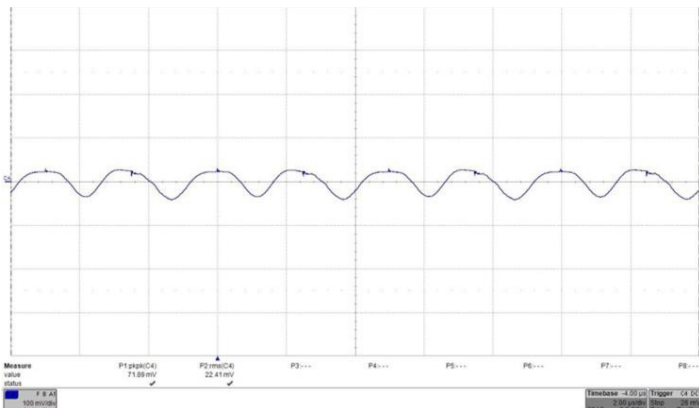


Fig. 31: Output voltage ripple (100 mV/div.) at full rated load current into a resistive load at Vin = 14V. Time: 2 μs /div.

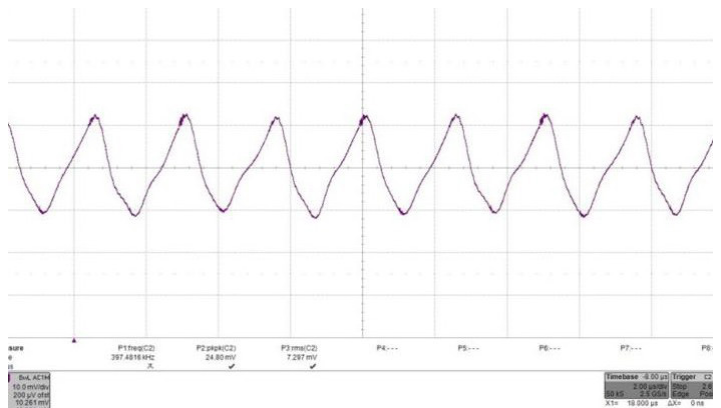


Fig. 32 Input reflected ripple current, i_c (500mA/mV), measured at input terminals at full rated load current at Vin = 24V. Refer to Fig. 2 for test setup. Time: 2 μs /div.
RMS input ripple current is $7.3 \times 0.5A = 3.65A_{RMS}$.

Characteristic Waveforms – 24S24.42FXW

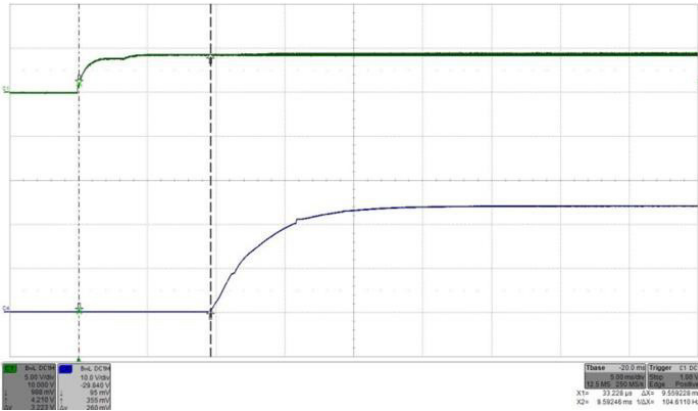


Fig. 33: Turn-on by ON/OFF transient (with Vin applied) at full rated load current (resistive) at Vin = 24V. Top trace (C1): ON/OFF signal (5 V/div.). Bottom trace (C4): Output voltage (10 V/div.). Time: 5 ms/div.

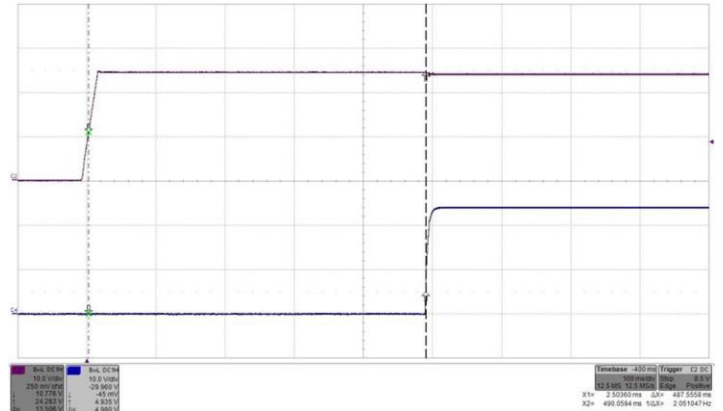


Fig. 34: Turn-on by Vin transient (ON/OFF high) at full rated load current (resistive) at Vin = 24V. Top trace (C2): Input voltage Vin (10 V/div.). Bottom trace (C4): Output voltage (10 V/div.). Time: 100 ms/div.

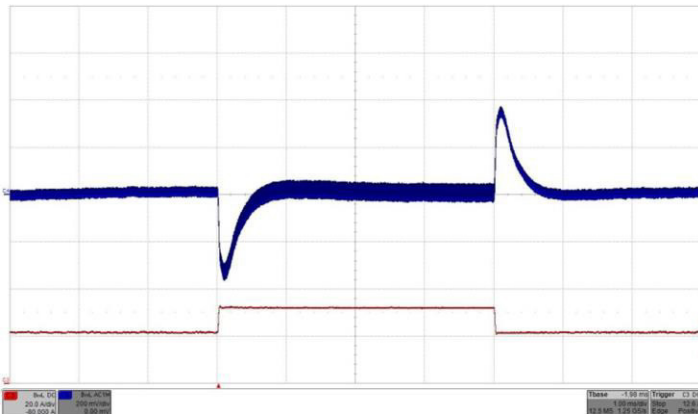


Fig. 35: Output voltage response to load current step change 50% - 75% - 50% (21A–31.5A–21A) with $di/dt = 1A/\mu s$ at Vin = 24V. Top trace (C4): Output voltage (200 mV/div.). Bottom trace (C3): Load current (20A/div.). Co = 470 μ F/70m Ω . Time: 1ms/div.

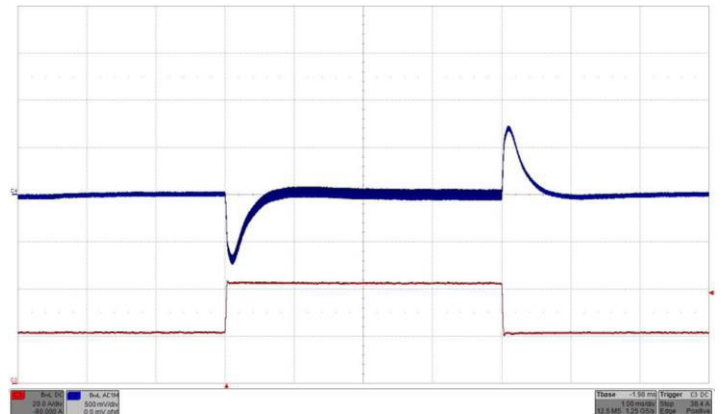


Fig. 36: Output voltage response to load current step change 50% - 100% - 50% (21A–42A–21A) with $di/dt = 1A/\mu s$ at Vin = 24V. Top trace (C4): Output voltage (500 mV/div.). Bottom trace (C3): Load current (20A/div.). Co = 2 x 470 μ F/70m Ω . Time: 1ms/div.

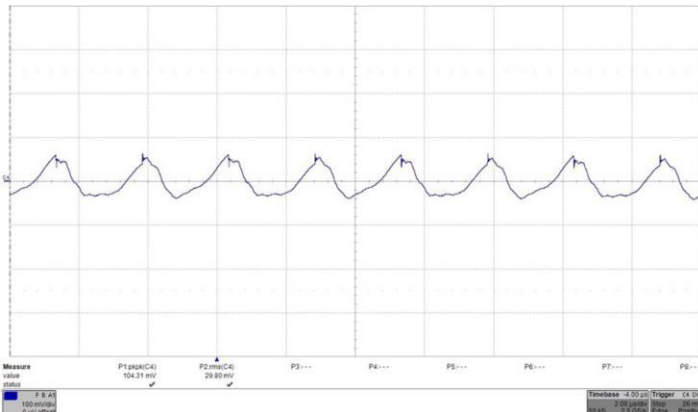


Fig. 37: Output voltage ripple (100 mV/div.) at full rated load current into a resistive load at Vin = 24V. Co = 2 x 470 μ F/70m Ω . Time: 2 μ s/div.

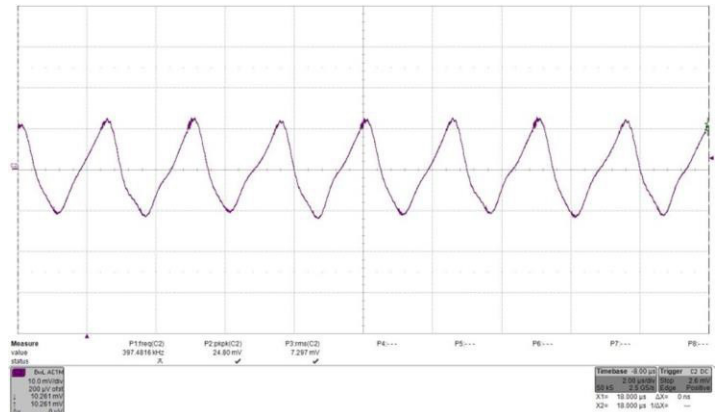


Fig. 38: Input reflected ripple current, i_c (500mA/mV), measured at input terminals at full rated load current at Vin = 24V. Refer to Fig. 2 for test setup. Time: 2 μ s/div. RMS input ripple current is $7.3 \cdot 0.5A = 3.65A_{RMS}$.

Characteristic Waveforms – 24S28.36FXT

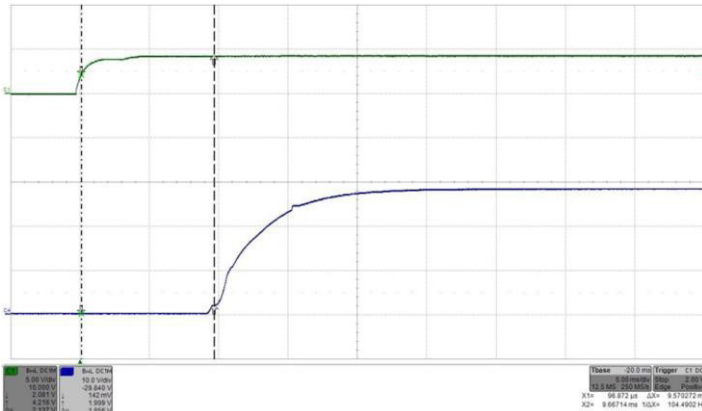


Fig. 39: Turn-on by ON/OFF transient (V_{in} applied) at full rated load current (resistive) at $V_{in} = 24V$. Top trace (C1): ON/OFF signal (5 V/div.). Bottom trace (C4): Output voltage (10 V/div.). Time: 5 ms/div.

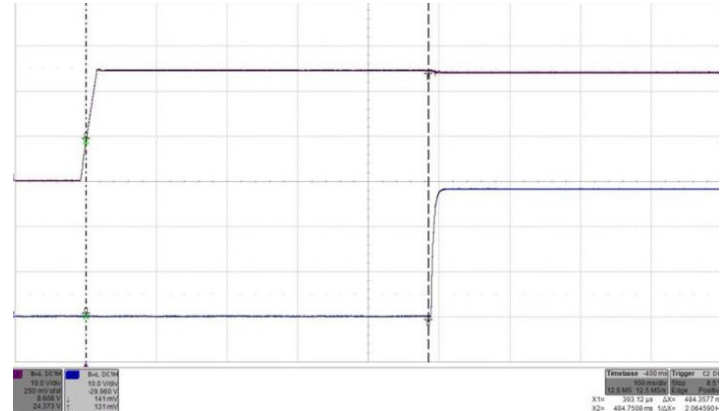


Fig. 40: Turn-on by V_{in} (ON/OFF high) transient at full rated load current (resistive) at $V_{in} = 24V$. Top trace (C2): Input voltage V_{in} (10 V/div.). Bottom trace (C4): Output voltage (10 V/div.). Time: 100 ms/div.

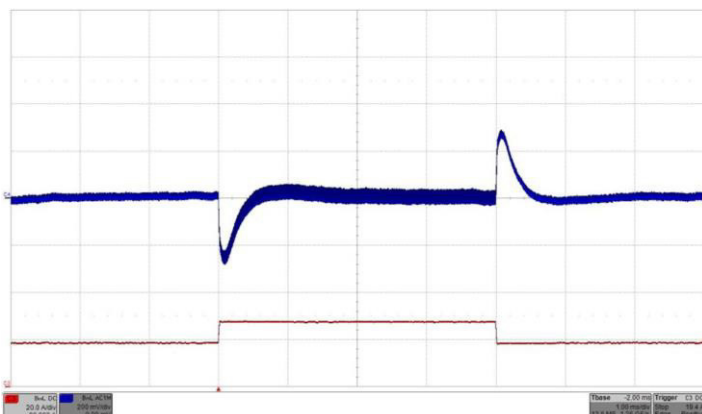


Fig. 41: Output voltage response to load current step change 50% - 75%- 50% (18A–27A–18A) with $di/dt = 1A/\mu s$ at $V_{in} = 24V$. Top trace (C4): Output voltage (200 mV/div.). Bottom trace (C3): Load current (10A/div.). $C_o = 470\mu F/70m\Omega$. Time: 1ms/div.

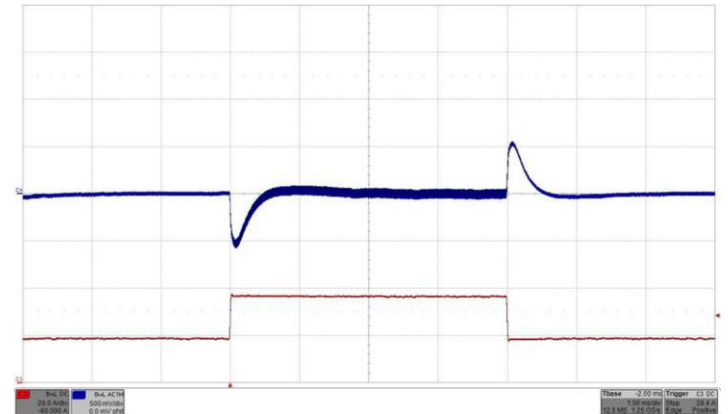


Fig. 42: Output voltage response to load current step change 50% - 100%- 50% (18A–36A–18A) with $di/dt = 1A/\mu s$ at $V_{in} = 24V$. Top trace (C4): Output voltage (500 mV/div.). Bottom trace (C3): Load current (10A/div.). $C_o = 470\mu F/70m\Omega$. Time: 1ms/div.

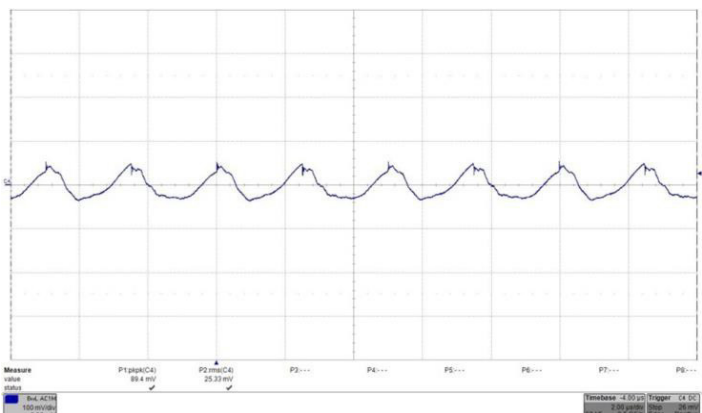


Fig. 43: Output voltage ripple (100 mV/div.) at full rated load current into a resistive load at $V_{in} = 24V$. $C_o = 470\mu F/70m\Omega$. Time: 2 μs /div.

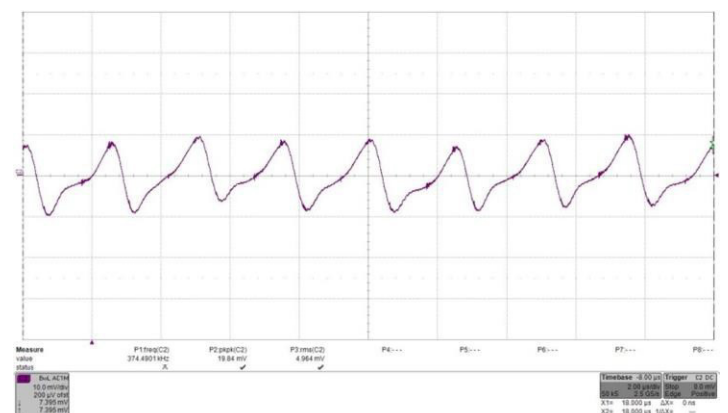


Fig. 44: Input reflected ripple current, i_c (500 mA/div.), measured at input terminals at full rated load current at $V_{in} = 24V$. Refer to Fig. 2 for test setup. Time: 2 μs /div. RMS input ripple current is $4.968 \times 0.5A = 2.48_{ARMS}$.

Characteristic Waveforms – 24S48.21FXT

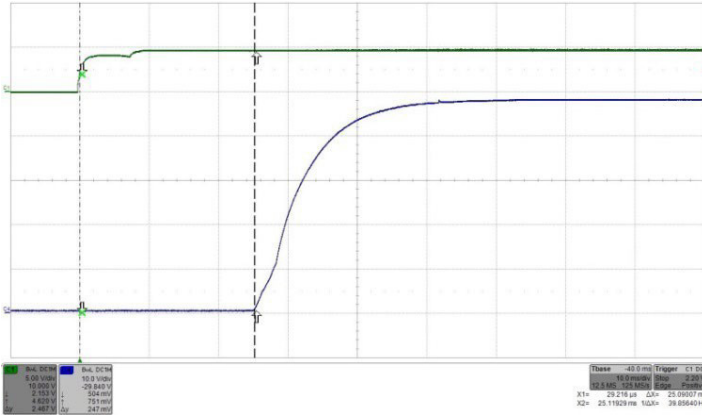


Fig. 45: Turn-on by ON/OFF transient (V_{in} applied) at full rated load current (resistive) at $V_{in} = 24V$. Top trace (C1): ON/OFF signal (5 V/div.). Bottom trace (C4): Output voltage (10 V/div.). Time: 10 ms/div..

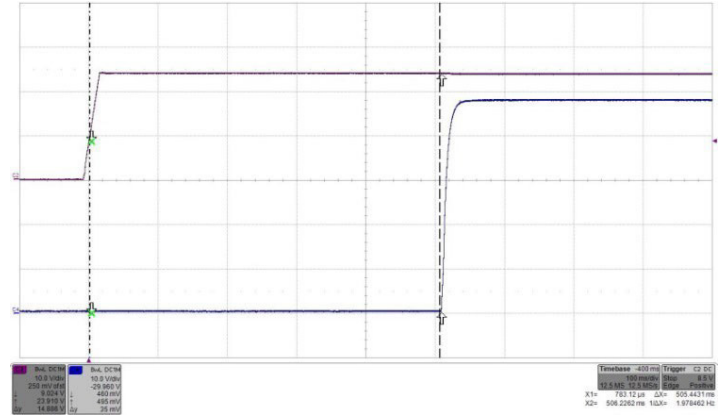


Fig. 46: Turn-on by V_{in} (ON/OFF high) transient at full rated load current (resistive) at $V_{in} = 24V$. Top trace (C2): Input voltage V_{in} (10 V/div.). Bottom trace (C4): Output voltage (10 V/div.). Time: 100 ms/div.

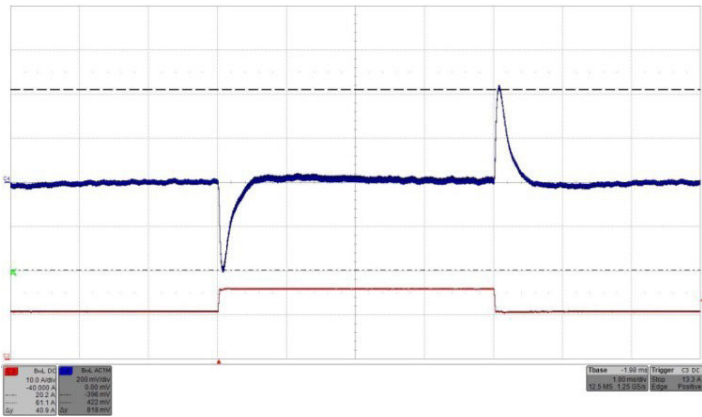


Fig. 47: Output voltage response to load current step change 50% - 75%- 50% (10.5A–15.75A–10.5A) with $di/dt = 1A/\mu s$ at $V_{in} = 24V$. Top trace (C4): Output voltage (200 mV/div.). Bottom trace (C3): Load current (10A/div.). Time: 1ms/div

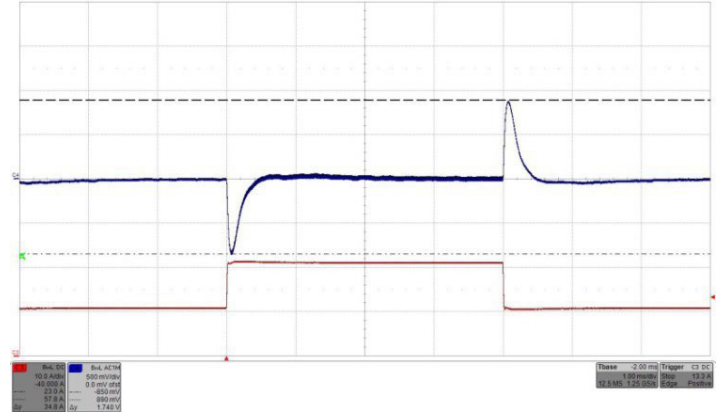


Fig. 48: Output voltage response to load current step change 50% - 100%- 50% (10.5A–21A–10.5A) with $di/dt = 1A/\mu s$ at $V_{in} = 24V$. Top trace (C4): Output voltage (500 mV/div.). Bottom trace (C3): Load current (10A/div.). Time: 1ms/div.

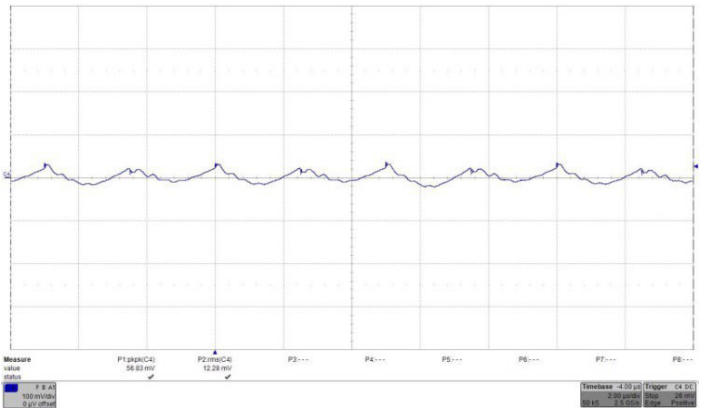


Fig. 49: Output voltage ripple (100 mV/div.) at full rated load current into a resistive load at $V_{in} = 24V$. Time: 2 μs /div.

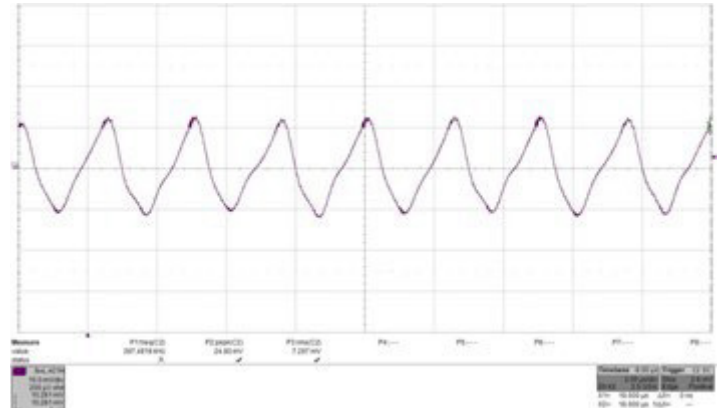


Fig. 50: Input reflected ripple current, i_c (500 mA/div.), measured at input terminals at full rated load current at $V_{in} = 24V$. Refer to Fig. 2 for test setup. Time: 2 μs /div. RMS input ripple current is $7.3 \cdot 0.5A = 3.65_{ARMS}$.

Characteristic Waveforms – 24S53.19FXT

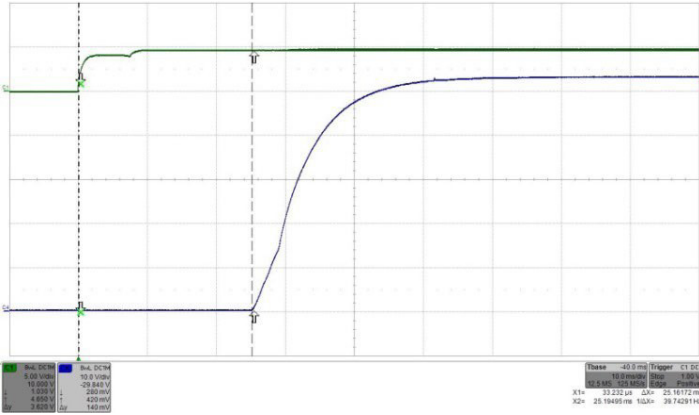


Fig. 51: Turn-on by ON/OFF transient (V_{in} applied) at full rated load current (resistive) at $V_{in} = 24V$. Top trace (C1): ON/OFF signal (5 V/div.). Bottom trace (C4): Output voltage (10 V/div.). Time: 10 ms/div.

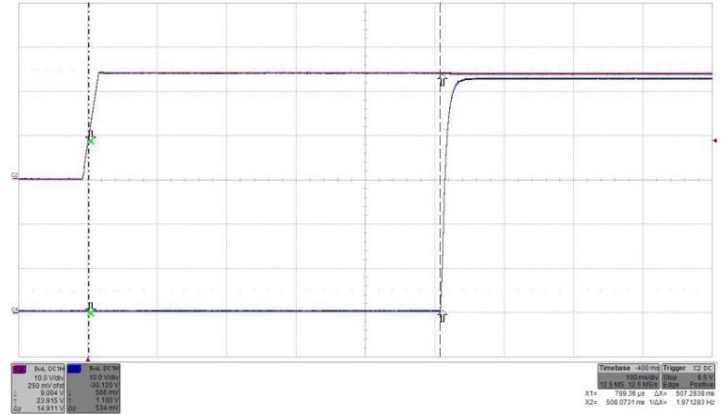


Fig. 52: Turn-on by V_{in} (ON/OFF high) transient at full rated load current (resistive) at $V_{in} = 24V$. Top trace (C2): Input voltage V_{in} (10 V/div.). Bottom trace (C4): Output voltage (10 V/div.). Time: 100 ms/div.

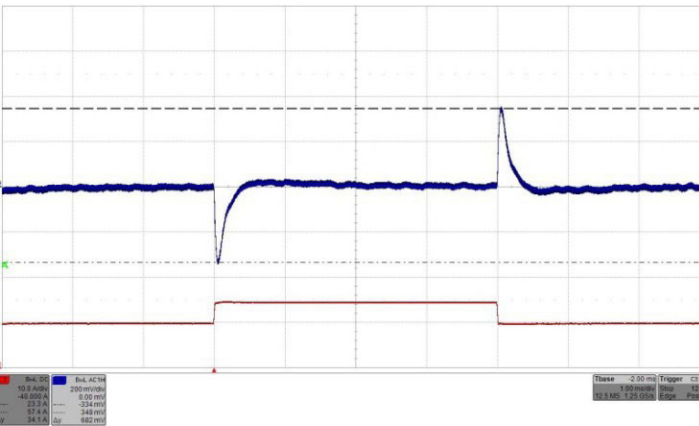


Fig. 53: Output voltage response to load current step change 50% - 75%- 50% (9.5A–14.25A–9.5A) with $di/dt = 1A/\mu s$ at $V_{in} = 24V$. Top trace (C4): Output voltage (200 mV/div.). Bottom trace (C3): Load current (10A/div.). Time: 1ms/div.

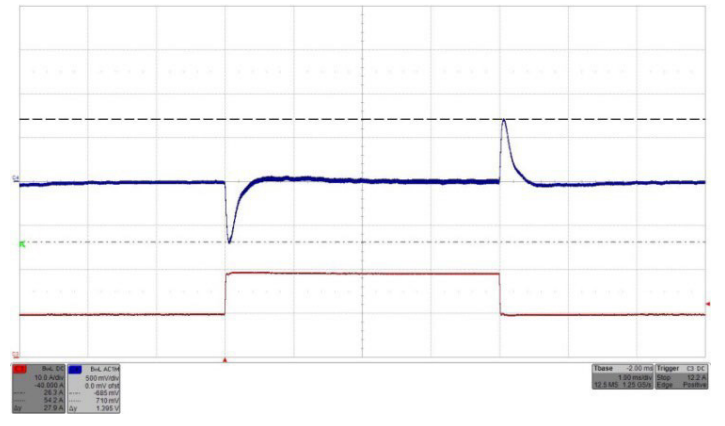


Fig. 54: Output voltage response to load current step change 50% - 100%- 50% (9.5A–19A–9.5A) with $di/dt = 1A/\mu s$ at $V_{in} = 24V$. Top trace (C4): Output voltage (500 mV/div.). Bottom trace (C3): Load current (10A/div.).

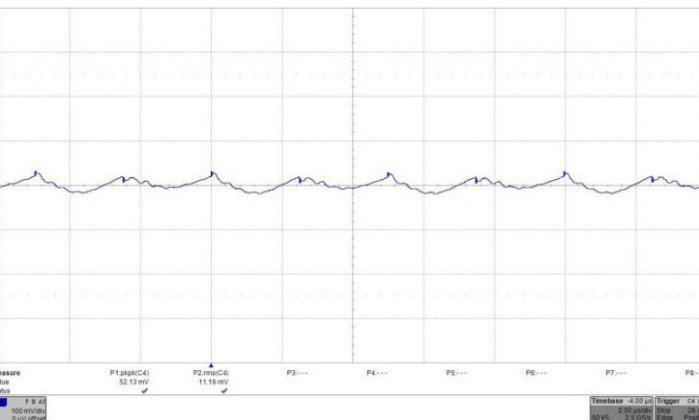


Fig. 55: Output voltage ripple (100 mV/div.) at full rated load current into a resistive load at $V_{in} = 24V$. Time: 2 μs /div.

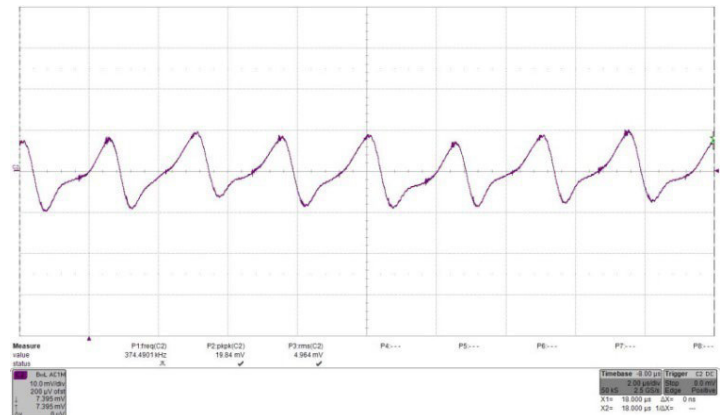
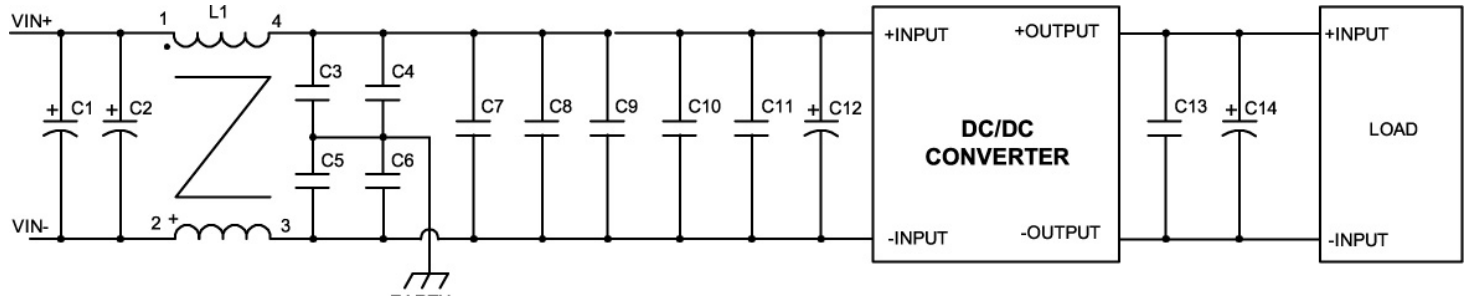


Fig. 56: Input reflected ripple current, i_c (500 mA/div.), measured at input terminals at full rated load current at $V_{in} = 24V$. Refer to Fig. 2 for test setup. Time: 2 μs /div. RMS input ripple current is $4.968 \times 0.5A = 2.48A_{RMS}$.

EMC Consideration

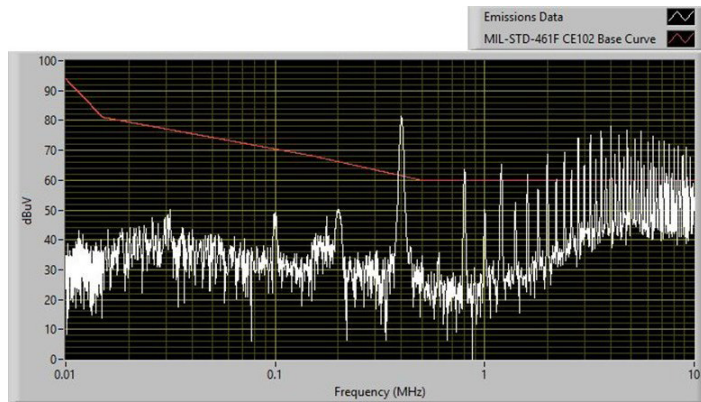
The filter circuit schematic for suggested input filter configuration as tested to meet the conducted emission limits of MILSTD-461F CE102 Base Curve is shown in Figure 57. The plots of conducted EMI spectrum measured using 5uH LISNs are shown in Figure 58.

Note: The customer is responsible for the proper selection, component rating, and verification of the suggested parts based on the end application.

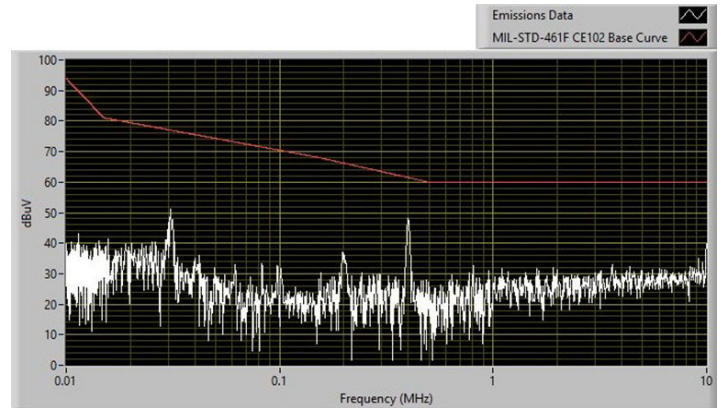


Component Designator	Description
C1, C2, C12, C14	470uF/50V/70mΩ Electrolytic Capacitor (Vishay MAL214699108E3 or equivalent)
C3, C4, C5, C6	4.7nF/1210/X7R/1500V Ceramic Capacitor
C7, C8, C9, C10, C11, C13	10μF/1210/X7R/50V Ceramic Capacitor
L1	CM choke, 130μH, Leakage = 0.6μH (4T on toroid 22.1 mm x 13.7 mm x 7.92 mm)

Fig. 57: Typical input EMI filter circuit to attenuate conducted emissions per MILSTD-461F CE102 Base Curve.



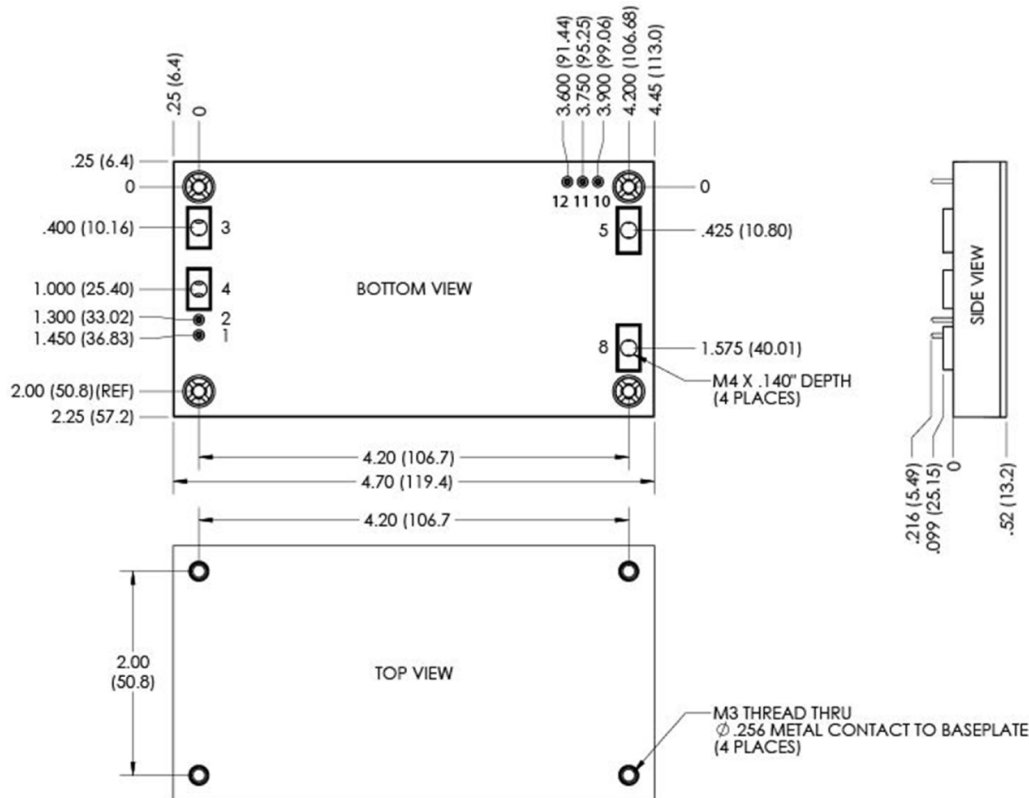
a) Without input filter from Fig. 47 (C9 = 2 x 470μF/50V/70mΩ)



b) With input filter from Fig. 47.

Fig. 58: Input conducted emissions measurement (Typ.) of 24S24.42FXW.

Mechanical Specifications



Input/ Output Connections

Pin	Label	Function	Pin	Label	Function
1	+ON/OFF	TTL input with internal pull up, referenced to ---ON/OFF pin, used to turn converter on and off	8	-OUT	Negative Output Voltage
2	-ON/OFF	Negative input of Remote ON/OFF	10	SENSE-	Negative Remote Sense
3	-INPUT	Negative Input Voltage	11	SENSE+	Positive Remote Sense
4	+INPUT	Positive Input Voltage	12	TRIM	Used to Trim output voltage +10/-40%
5	+OUT	Positive Output Voltage			

Notes:

Pinout as well as pin number and pin diameter are inconsistent between manufacturers of the full brick converters. Ensure to follow the pin function, (not the pin number) and the specification for pin diameter when laying out the board.

Unless otherwise specified: All dimensions are in inches [millimeter]
 Tolerances: x.xx in. ±0.02 in. [x.x mm ± 0.5mm]
 x.xxx in. ±0.010 in. [x.xx mm ± 0.25mm]

Torque fasteners into threaded mounting inserts at 10 in.lbs. or less. Greater torque can result in damage to the unit and void the warranty.